



佛山市国星光电股份有限公司
FOSHAN NATIONSTAR OPTOELECTRONICS CO., LTD

产品规格书

SPECIFICATION

顾客名称 Customer		产品名称 Product	TOP LED
顾客型号 Customer Type		产品型号 Type	NTD3528G1
顾客部品号 Customer No.		版本号 Version NO	C0 版



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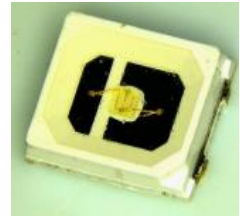
NTD3528G1

TOP Light Emitting Diode

技术数据表 Technical Data Sheet

本产品在小尺寸上集成了高光量子通量、高光合量子效率、长寿命等优点，高可靠性，支持表面贴装技术。

This product combines high photosynthetic photon flux(PPF), high photosynthetic photon flux efficiency(PPE), long working life and high reliability with small package, support for SMT.



特性:

Features:

- 管芯材料: InGaN/GaN 发光波长: 520nm
Material: Emitting Wavelength:520nm
- 封装材料: 硅胶
Encapsulation: Silicone
- 焊接方法: 无铅回流焊
Soldering methods: Pb-Free reflow soldering
- 光强高, 功耗低, 可靠性好, 寿命长
High Luminous Intensity ,Low Power Dissipation, good Reliability and Long Life
- 符合欧盟公布的 ROHS 指令要求
Complied With ROHS Directive

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电性参数

Electrical Characteristics

◇ 极限参数 (温度=25°C)
Absolute Maximum Ratings (Temperature=25 °C)

参数名称 Parameter	符号 Symbol	数值 Rating	单位 Unit
正向电流 Forward Current	IF	200	mA
正向脉冲电流* Pulse Forward Current*	IFP	500	mA
反向电压 Reverse Voltage	VR	5	V
结温 Junction Temperature	Tj	115	°C
工作温度 Operating Temperature	TOPR	-30 ~ +85	°C
贮存温度 Storage Temperature	Tstg	-40 ~ +100	°C
焊接温度 Soldering Temperature	Tsol	回流焊 (245°C 10 秒) Reflow soldering (245°C for 10sec)	

* 注: 脉冲宽度≤0.1ms, 占空比≤1/10 * Note: Pulse Width≤0.1ms, Duty≤1/10

◇ 光电参数 (温度=25°C)
Electro-Optical Characteristics(Temperature=25 °C)

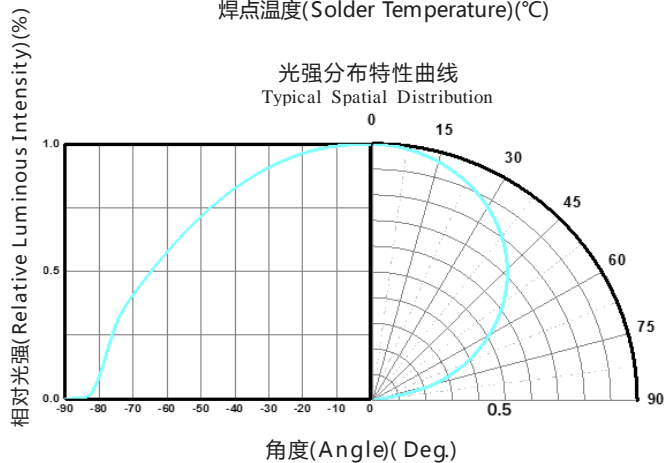
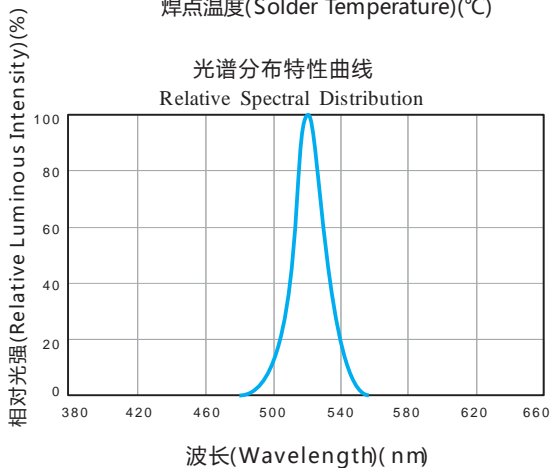
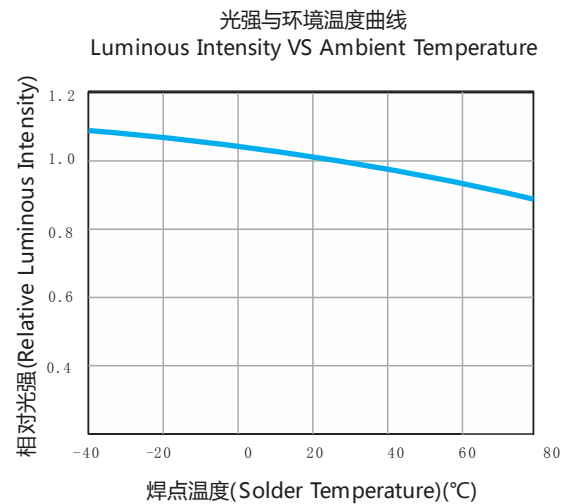
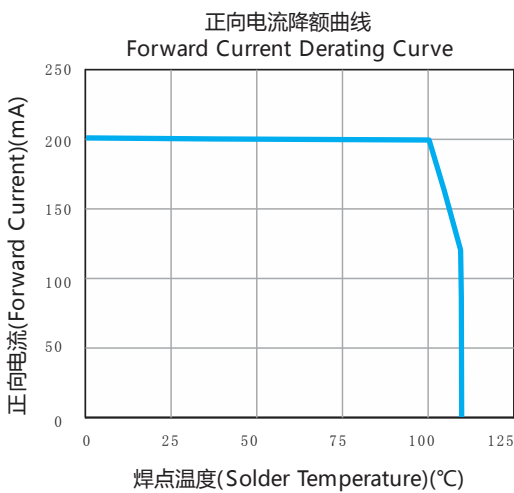
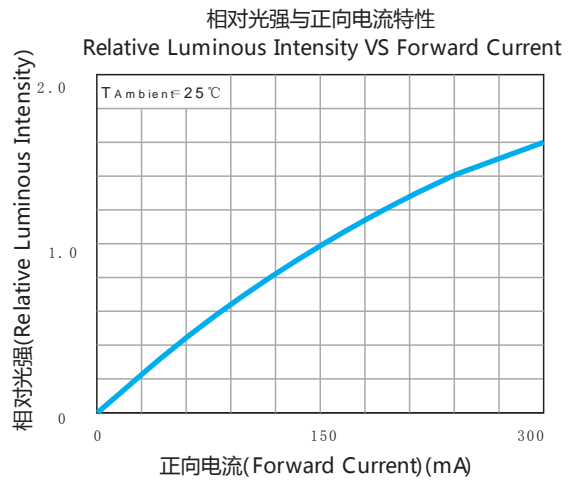
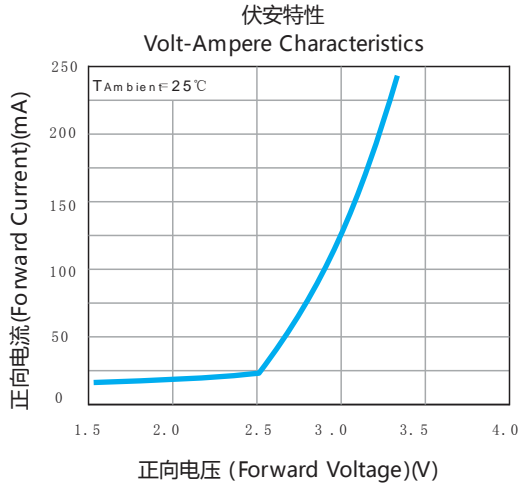
参数名称 Parameter	符号 Symbol	条件 Condition	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit
反向电流 Reverse Current	IR	VR=5V	-	-	10	μA
视角度 View Angle	2θ1/2	-	-	125	-	deg.
正向电压 Forward Voltage	VF	IF=150mA	3.0	3.2	3.4	V
光功率 Radiometric	Φe		100	115	130	mW
峰值波长 Peak Wavelength	λP		515	520	525	nm
半波宽度 Spectrum Radiation Bandwidth	Δλ		-	30	-	nm

* 注: 光功率偏差±15%; 压降偏差±0.1V; 波长偏差±1nm。

* Note: Tolerance of Radiometric bin is ±15%; Tolerance of Forward Voltage bin is ±0.1V; Tolerance of Wavelength ±1nm.

典型特性曲线

Typical Characteristics Curves





可靠性试验

Reliability Test Items And Conditions

实验项目 Test Items	参考标准 Reference	实验条件 Test Conditions	时间 Time	样品数 Quantity	判据 Criterion
冷热冲击 Thermal Shock	JESD22-A104	-40°C(30min)←→100°C(30min)	100 cycles	22	0/22
高温贮存 High Temperature Storage	JESD22-A103	Ta=100°C	1000h	22	0/22
低温贮存 Low Temperature Storage	JESD22-A119	Ta=-40°C	1000h	22	0/22
常温寿命 Lifespan Test	JESD22-A108	Ta=25°C, IF=150mA	1000h	10	0/10
高温寿命试验 High Temperature Life Test	JESD22-A108D	Ta=85°C, IF=150mA	1000h	10	0/10
高温高湿寿命 High Temperature High Humidity	JESD22-A101	85°C ± 5°C/85%RH IF=150mA	1000h	10	0/10
耐焊接热 Resistance to Soldering Heat	JESD22-B106	Temp:245°C max T=10sec	3 times	22	0/22

失效判断标准 Criteria For Judging Damage

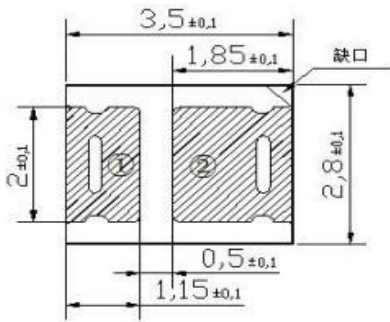
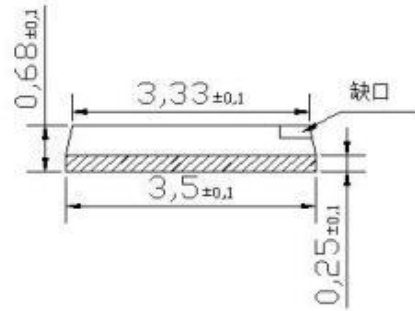
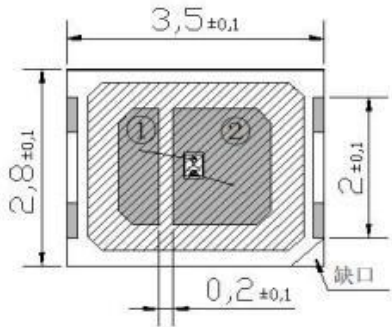
测试项目 Test Items	符号 Symbol	测试条件 Test Conditions	判定标准 Criteria For Judging Damage
正向电压 Forward Voltage	V _F	I _F = I _{FT}	初始值±10% Initial Data ±10%
反向电流 Reverse Current	I _R	V _R = 5V	I _R ≤10μA
光功率 Radiometric	Φ _e	I _F = I _{FT}	平均 Φ _e 衰减≤30%, 单个 Φ _e 衰减≤50% Average Φ _e degradation ≤30%; Single LED Φ _e e degradation ≤50%
耐焊接热 Resistance to Soldering Heat			无死灯 No dead light

注: Tsol-锡液温度; I_{FT}: 典型电流

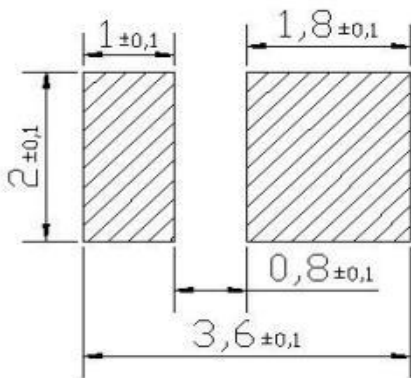
* Note: Tsol-Temperature of tin liquid; I_{FT}: Typical current.

外形尺寸

Outline Dimension



焊盘建议大小 Recommended size of pad



焊点结构 Pad Configuration:

焊点 Pad	功能 Function
1	负极 Cathode
2	正极 Anode

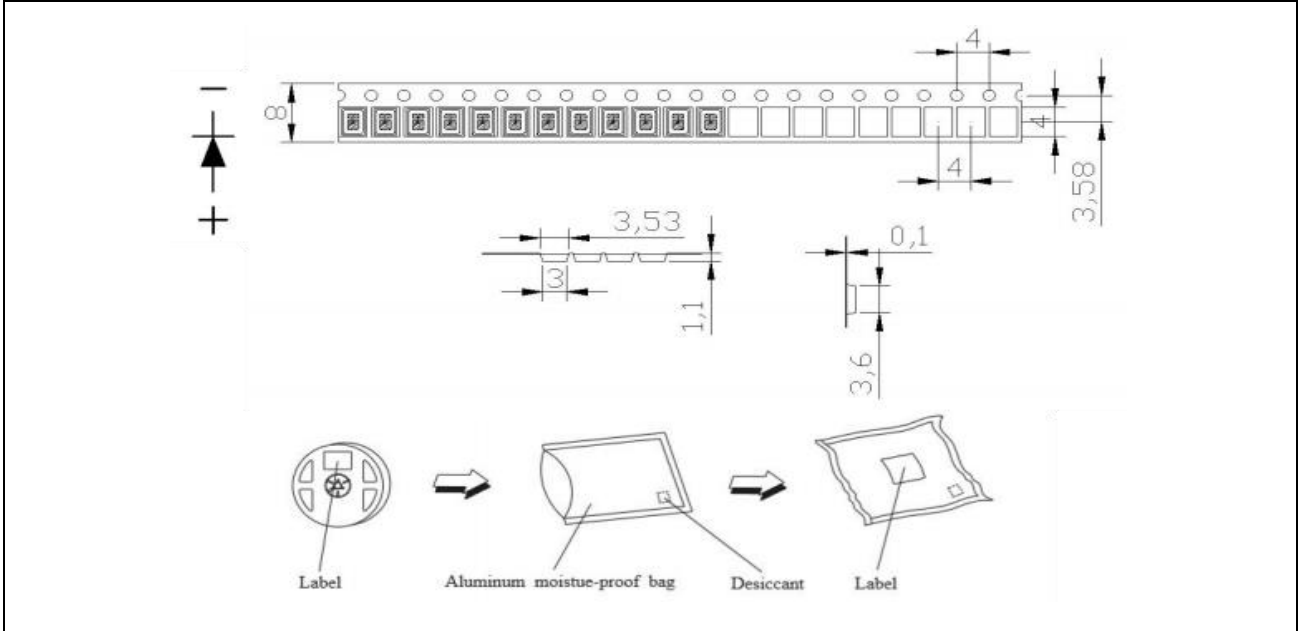
备注(Note):

- 标注尺寸单位为毫米
Dimensions are in millimeters.
- 除特别标注外, 所有尺寸允许公差±0.1mm.
Tolerances unless mentioned are ±0.1mm.

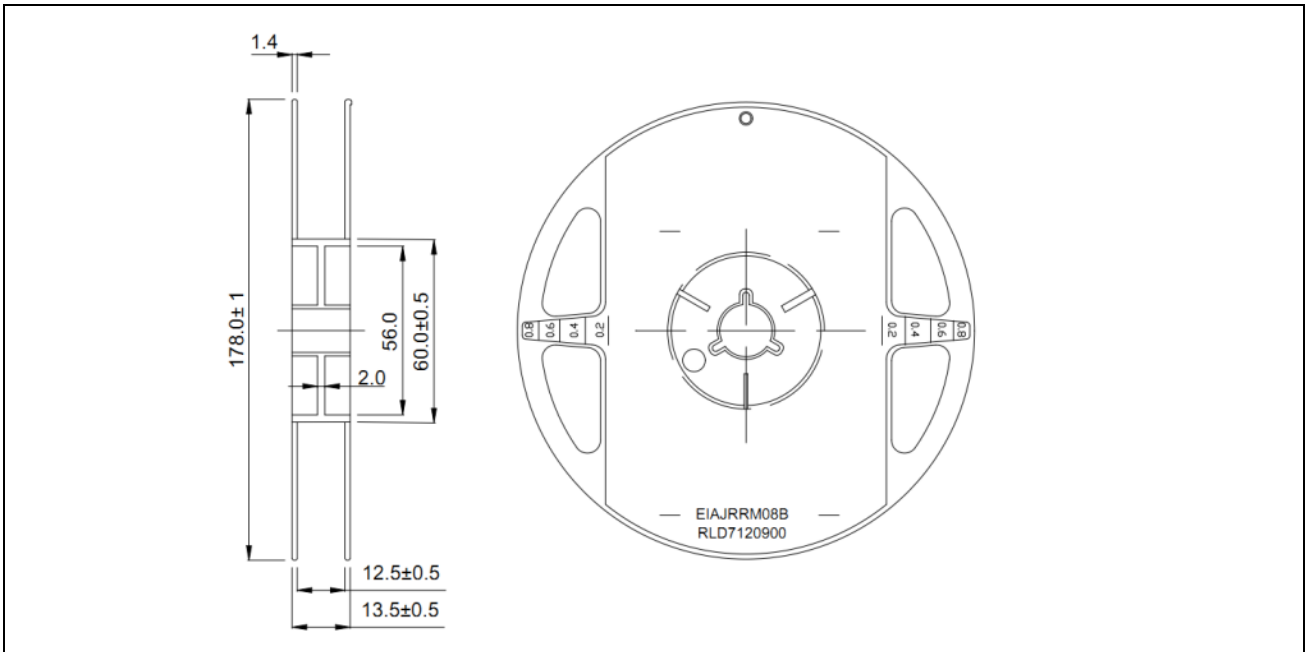
包装

Packaging

(1)载带 Carrier Tape



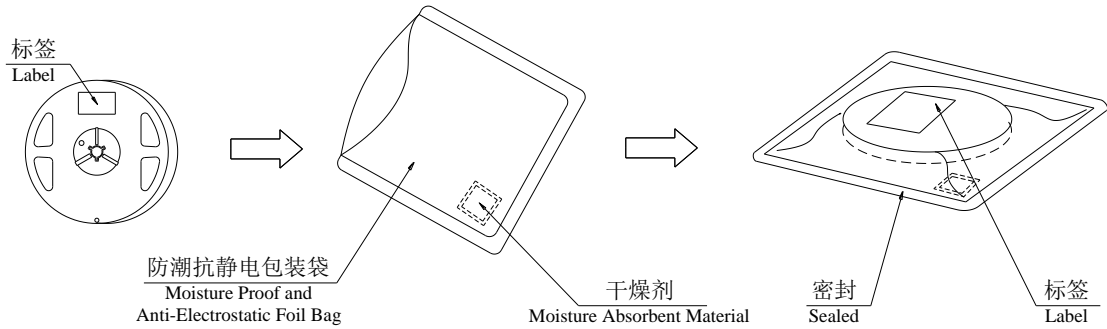
(2)带盘 Reel Dimension



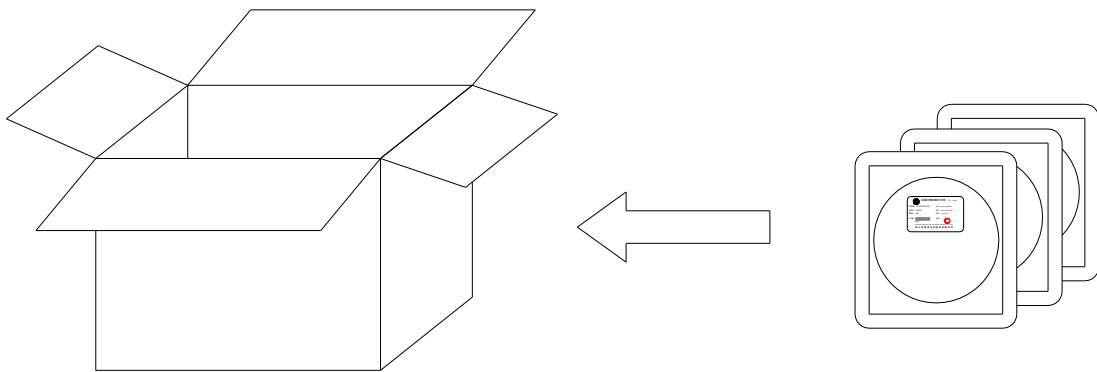
Loaded quantity 4000PCS per reel



◇ 防潮抗静电真空包装 Moisture Proof and Anti-Electrostatic Foil Bag



◇ 外包装箱 Cardboard Box



◇ 标签说明 Label Explanation

TYPE : 产品型号 Product model

QTY : 数量 Quantity

BIN : 分档 Rank

SC : 生产编码 Production code

LOT : 批号 Lot Number

Φ_e (mW) : 光功率范围 Radiometric Range

VF : 正向电压范围 Forward Voltage

IF : 测试电流 Test Current

λ_p : 峰值波长 Peak Wavelength

	TOP LED	IF =	mA
TYPE:			
QTY:	PCS	λ_p (nm):	
BIN:		Φ_v (lm):	
SC:		Φ_e (mW):	
LOT:		VF(V):	
		QC:	
Foshan NationStar Optoelectronics Co.,Ltd			
佛山市国星光电股份有限公司			

备注: 标签模板仅供参考, 请以实际参数为准!



焊接指导

Guideline for Soldering

1. 使用烙铁人手焊接

Hand Soldering

建议使用防静电电烙铁, 尖端处温度不超过 350°C, 每次焊锡时少于 3 秒。电烙铁的功率宜低于 60W。每焊完一次之后间隔 2 秒以上, 分别焊好两个电极引脚。焊接时不可对透镜用力施压。LED 如有问题一般都是从焊锡时开始出现。故必须按要求小心作业。

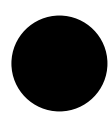
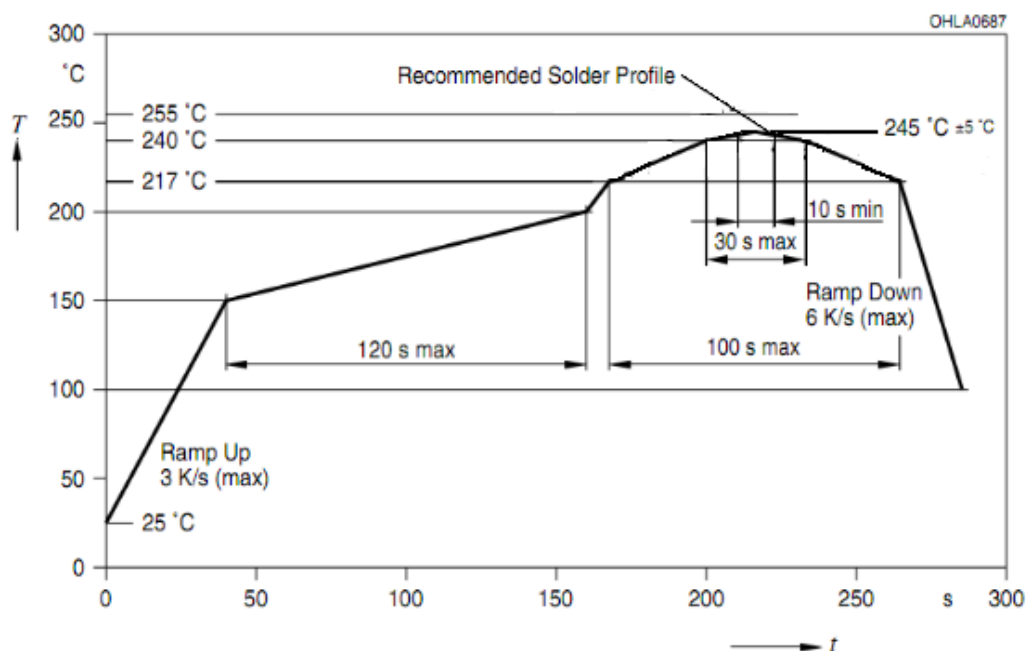
人手焊接过程中的不慎操作易引起 LED 产品的损坏, 应当小心谨慎。

It is recommended to use anti-static electric soldering iron, the temperature at the tip does not exceed 350°C, less than 3 seconds for each soldering. The power of the soldering iron should be less than 60W. Weld two electrode pins more than 2 seconds after each welding. Do not force the lens during welding. Problems with leds usually begin when they are soldered. So you must work carefully as required.

Be careful because the damage of the product is often started at the time of the hand soldering.

2. 回流焊接: 推荐使用以下无铅回流焊接温度图进行。

Reflow Soldering: Use the conditions shown in the under Figure of Pb-Free Reflow Soldering.



■ **注意事项 matters need attention:**

1. 回流焊只允许做一次。

Reflow soldering is only allowed once.

2. 回流焊过程中不要对灯体施加压力。

Do not apply pressure to the lamp body during reflow

3. 流焊完成之后不要压挤散热板、不可压到胶体部分。

After reflow welding is completed, do not press the heat dissipation plate, do not press to the colloidal part.

4. 有比较低熔点的锡膏, TP 可以适当降低。

If there is a lower melting point of solder paste, TP can be appropriately reduced.

3. **清洗:**

Cleaning

在焊接后推荐使用酒精进行清洗, 在温度不高于 30°C 的条件下持续 3 分钟, 不高于 50°C 的条件下持续 30 秒。使用其他类似溶剂清洗前, 请先确认使用的溶剂不会对 LED 的封装和环氧胶部分造成损伤。

超声波清洗也是有效的方法, 一般最大功率不应超过 300W, 否则可能对 LED 造成损伤。请根据具体的情况预先测试清洗条件是否会对 LED 造成损伤。

It is recommended that alcohol be used as a solvent for cleaning after soldering. Cleaning is to go under 30°C for 3 minutes or 50°C for 30 seconds. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not.

Ultrasonic cleaning is also an effective way for cleaning. But the influence of Ultrasonic cleaning on LED depends on factors such as ultrasonic power. Generally, the ultrasonic power should not be higher than 300W. Before cleaning, a pre-test should be done to confirm whether any damage to LEDs will occur.

* **注意:** 此一般指导原则并不适用于所有 PCB 设计和焊接设备的配置。具体工艺受到诸多因素的影响, 请根据特定的PCB设计和焊接设备来确定焊接方案。

* **Note:** This general guideline may not apply to all PCB designs and configurations of all soldering equipment. The technique in practice is influenced by many factor, it should be specialized base on the PCB designs and configurations of the soldering equipment.



使用注意事项

Precautions

1. 保存及使用:

Preservation and use

在打开包装前, LED 应存放在 30°C/60%RH 或以下的环境中。打开包装后, LED 应置于 20-30°C/30%RH 或以下的环境中使用。

Before opening the package, the LED should be stored at 30°C/60%RH or less. After opening the package, the LED should be placed in an environment of 20-30°C/30%RH or less.

Molding 封装及 SMD LED 开封后要在 24H 之内使用, 为了避免环境的影响, 建议拆封后, 经过 60°C /24H 除湿, 没用完 LED 需及时做抽真空包装处理, 避免再次使用时发生失效。

To avoid the impact of the environment, it is recommended to dehumidify after unpacking at 60°C/24H. All the leds are needed to be vacuumed to avoid failure

若干燥剂褪色或过期使用, 需干燥烘烤: 60±5°C/24 小时。

If the desiccant faded or expired use, dry baking: 60±5°C/24 hours.

LED 的胶表面易沾灰尘, 需要做好相关防尘措施。

LED Glue surface easy to dust, need to do the relevant dust prevention measures.

2. 静电:

Static Electricity

静电和电涌会导致产品特性发生改变, 例如正向电压降低等, 如果情况严重甚至会损毁产品。所以在使用时必须采取有效的防静电措施。

所有相关的设备和机器都应该正确接地, 同时必须采取其他防止静电和电涌的措施。

使用防静电手环, 防静电垫子, 防静电工作服、工作鞋、手套, 防静电容器, 都是有效的防止静电和电涌的措施。

Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristic such as the forward voltage becomes lower, or the LEDs do not light at the low current. even not light.

All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wrist bands or anti-electrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs.



3. 硫化:

Vulcanization

LED 硫化是由于环境中的硫进入支架内部与+1 价的银发生化学反应生成黑色 Ag_2S 的过程。该过程会导致支架镀银层的反光能力下降, 色温漂移和光衰严重, 很大程度上影响了产品性能。因此, 在使用时应注意采取相应的防硫措施, 如避免使用挥发性强的含硫物质, 避免接触含硫较高的物质。

LED curing is due to sulfur being in bracket and the +1 price of silver in the chemical reaction generated Ag_2S in the process. It will lead to the capacity of reflecting of silver layer reducing , light color temperature drift and serious decline ,seriously affecting the performance of the product.So we should take corresponding measures to avioding vulcanization, such as to avoid using sulphur volatile substances and keeping away from high sulphur content of the material.

4. 眼睛保护忠告:

Safety Advice For Human Eyes

LED 发光时, 请勿直视发光光源, 特别是对于一些光强较高的 LED, 强光可能伤害你的眼睛。

Viewing direct to the light emitting center of the LEDs, especially those of great Luminous Intensity will cause great hazard to human eyes. Please be careful.

5. 设计建议:

Design Consideration

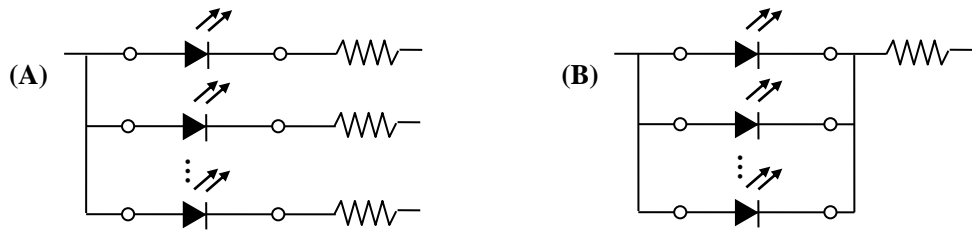
设计电路时, 通过 LED 的电流不能超过规定的最大值, 同时, 还需使用保护电阻, 否则, 微小的电压变化将会引起较大的电流变化, 可能导致产品损毁。

建议使用以下 (A) 电路, 该电路能够很好的调节通过每个 LED 的电流; 不推荐使用 (B) 电路, 该电路在持续的电压驱动下, LED 的正向电压 (V_F) 发生变化, 电流会随之而发生变化, 可能使某些 LED 承受高于规定的电流值。

In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LED. In the meanwhile, resistors for protection should be applied, otherwise slight voltage shift will cause big current change, burn out may happen.

It is recommended to use Circuit A which regulates the current flowing through each LED rather than Circuit B. When driving LEDs with a constant voltage in Circuit B, the current through the LEDs may vary due to the variation in Forward Voltage (V_F) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the Absolute Maximum Rating.





LED 的特性容易因为自身的发热和环境的温度的改变而发生改变。温度的升高会降低 LED 的发光效率、影响发光颜色等，所以在设计时应充分考虑散热的问题。

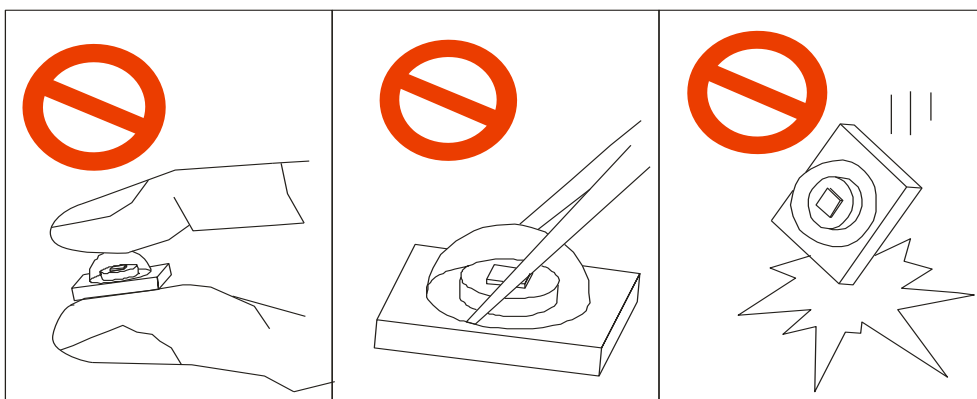
Thermal Design is paramount importance because heat generation may result in the Characteristics decline, such as brightness decreased, Color changed and so on. Please consider the heat generation of the LEDs when making the system design.

6. 其他事项:

Others

直接用手拿取产品不但会污染封装胶表面，也可能由于静电等因素导致产品性能的改变。过度的压力也可能直接影响封装内部的管芯和金线，因此请勿对产品施加过度压力，特别当产品处于高温状态下，例如在回流焊接过程中。

When handling the product, touching the encapsulant with bare hands will not only contaminate its surface, but also affect on its optical characteristic. Excessive force to the encapsulant might result in catastrophic failure of the LEDs due to die breakage or wire deformation. For this reason, please do not put excessive stress on LEDs, especially when the LEDs are heated such as during Reflow Soldering.



LED 的硅胶封装部分相当脆弱，请勿用坚硬、尖锐的物体刮、擦封装胶部分。在用镊子夹取的时候也应当小心注意。

The silicon resin of encapsulant is fragile, so please avoid scratch or friction over the epoxy resin surface. While handling the product with tweezers, do not hold by the epoxy resin, be careful.



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